# DATASHEET - BF-U-4/132-G-C



Complete flush-mounted flat distribution board, grey, 33 SU per row, 4 rows, type  ${\bf C}$ 



Part no. BF-U-4/132-G-C Catalog No. 103100

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Delivery program			
Basic function			Basic device
Product function			Installation distribution boards
Product range			BF flat DBO
Design			Hollow wall Flush mounted
Installation site			Indoor
Type of installation			Hollow-wall mounting and flush mounting
Door/Flap			Gray
Degree of Protection			IP30
Colour			Grey
Module rack			Rail-frame
Shroud for protection against accidental contact			Metal
Rows	Count		4
Module units per row			33
Description			IP30 Protection Class I Steel sheet enclosure grey (RAL 7035)
Cable entries			Cable entries on top and bottom
PE and N terminals design			Screw terminals
PE and N terminals	Number x cross- sectional area	mm <sup>2</sup>	PE: 2 x 25 + 58 x 16 N: 2 x 25 + 58 x 16
Equipment supplied			Wall trough with door frame Door with three-point turn-lock DIN rail mounting frame Front plates Neutral-/protective conductor terminal

#### **Technical data**

#### General

delicial				
Standards			IEC/EN 61439-1, IEC/EN 61439-3, IEC/EN 62208	
RoHS (in accordance with Directive 2002/95/EC of the European Parliament and Council)			conform	
Ambient temperature		°C	-5 - +40	
Degree of Protection			IP30	
Protection class			I (earthed)	
Rated operational voltage	Ue	V AC	415	
Rated frequency	f	Hz	50/60	
Material characteristics				
Material			Sheet steel, powder-coated	
Colour			Gray (RAL 7035)	
Material properties				
Mechanical				
Impact resistance			IK07	

### Design verification as per IEC/EN 61439

Technical data for design verification			
Heat dissipation, at an ambient temperature of 35°C, delta T: 20 degrees in top of the enclosure, calculated as per IEC 60890			
Individual enclosure, flush mounting	$P_{V}$	W	60
Heat dissipation, at an ambient temperature of 35°C, delta T: 35 degrees in top of the enclosure, calculated as per IEC 60890			

provide heat dissipation data for the devices.  10.11 Short-circuit rating Is the panel builder's responsibility.  10.12 Electromagnetic compatibility Is the panel builder's responsibility.	Individual enclosure, flush mounting	$P_V$	W	120
10.2.2 Corrosion resistance 10.2.3.1 Verification of thermal stability of enclosures Meets the product standard's requirements. 10.2.3.2 Verification of resistance of insulating materials to normal heat Meets the product standard's requirements.  10.2.4 Resistance to ultra-violet (UV) radiation Not relevant to indoor installations. Does not apply to enclosures without lifting aids. IKO7  10.2.7 Inscriptions Meets the product standard's requirements.  10.3 Degree of protection of ASSEMBLIES IP30  10.4 Clearances and creepage distances Is the panel builder's responsibility.  10.5 Protection against electric shock 10.6 Incorporation of switching devices and components Is the panel builder's responsibility.  10.7 Internal electrical circuits and connections Is the panel builder's responsibility.  10.9 Insulation properties  10.9.2 Power-frequency electric strength U <sub>1</sub> = 415 V AC  10.9.3 Impulse withstand voltage Does not apply to basic enclosures a defined in EN 62208.  10.9.4 Testing of enclosures made of insulating material Does not apply to metal enclosures.  The panel builder's responsibility.  10.10 Temperature rise The panel builder's responsibility.  10.11 Short-circuit rating Is the panel builder's responsibility.	IEC/EN 61439 design verification			
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	10.11 Short-circuit rating			Is the panel builder's responsibility.
10.12 Machanical function	10.12 Electromagnetic compatibility			Is the panel builder's responsibility.
10.15 Meetianical function	10.13 Mechanical function			Meets the product standard's requirements.

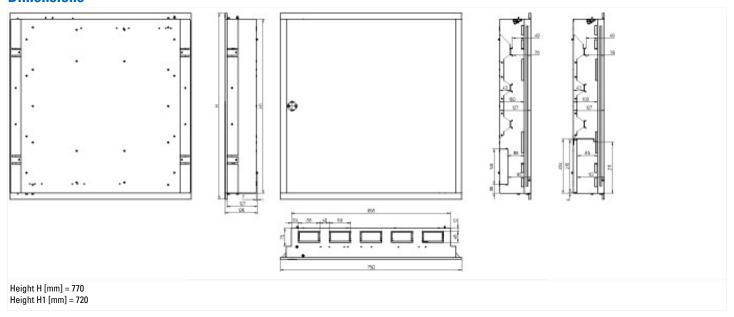
### **Technical data ETIM 7.0**

Distribution boards (EG000023) / Small distribution board (EC000214)

Electric engineering, automation, process control engineering / Electrical installation, device / Electrical distribution system (incl. small distribution board) / Small distribution board (ecl@ss10.0.1-27-14-24-09 [ACN387011])

(ecl@ss10.0.1-27-14-24-09 [ACN387011])		
Mounting method		Flush mounted (plaster)
Number of rows		4
Width in number of modular spacings		33
Type of cover		Door
Cover model		Closed
Transparent cover/door		No
Material housing		Steel
Height	mm	770
Width	mm	750
Depth	mm	136
Built-in depth	mm	127
Internal depth	mm	127
DIN-rail		Yes
With mounting plate		No
Extension possible		No
EMC-version		No
Colour		Grey
RAL-number		7035
Degree of protection (IP)		IP30
With lock		No
Type of closure		Other

# **Dimensions**



# Additional product information (links)

Product overview (Web)

http://www.eaton.eu/DE/Europe/Electrical/ProductsServices/Residential/index.htm